



THE DATASHEET OF MB8S-TP



	E502650
---	----------------

Features

- Halogen Free Available Upon Request By Adding Suffix "-HF"
- Glass Passivated Chip Junction
- Moisture Sensitivity Level 1
- Surface Mount Package
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant (Note 1)("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings @ 25°C (Unless Otherwise Specified)

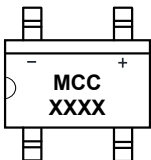
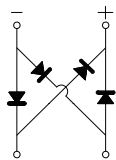
Parameter	Symbol	Value							Unit
		MB 05S	MB 1S	MB 2S	MB 4S	MB 6S	MB 8S	MB 10S	
Peak Repetitive Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Working Peak Reverse Voltage	V_{RWM}								
DC Blocking Voltage	V_R								
RMS Reverse Voltage	V_{RMS}	35	70	140	280	420	560	700	V
Average Rectified Forward Current @ See Fig.1	$I_{F(AV)}$	0.5(Note 2) 0.8(Note 3)							A
Non-Repetitive Peak Surge Current @ 8.3ms Half Sine Wave	I_{FSM}	35							A
Non-Repetitive Peak Surge Current @ 1ms Square Wave		60							
Current Squared Time @ $1ms \leq t \leq 8.3ms$	i^2t	5							A ² s

**0.5 Amp
Single Phase
Bridge Rectifier
50 to 1000 Volts**

Marking Code

Part Number	Marking Code
MB05S	MB05S
MB1S	MB1S
MB2S	MB2S
MB4S	MB4S
MB6S	MB6S
MB8S	MB8S
MB10S	MB10S

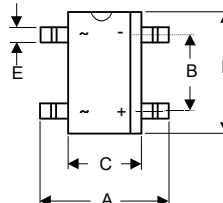
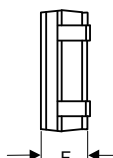
Internal Structure

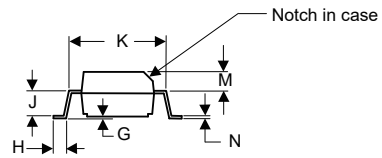
Simplified Outline	Graphic Symbol
 <p>XXXX = Marking Code</p>	

Note:

- 1.High temperature solder exemption applied, see EU directive annex 7a.
- 2.On glass epoxy P.C.B. mounted on 0.05 x 0.05"(1.3 x 1.3mm) pads
- 3.On aluminum substrate P.C.B. with an area of 0.8" x 0.8"(20 x 20mm) mounted on 0.05 x 0.05"(1.3x 1.3mm) solder pad

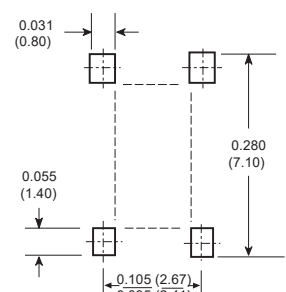
MBS-1



DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	0.252	0.276	6.40	7.00	
B	0.095	0.106	2.41	2.70	
C	0.142	0.165	3.60	4.20	
D	0.179	0.195	4.55	4.95	
E	0.019	0.031	0.50	0.80	
F	0.090	0.106	2.30	2.70	
G	0.002	0.008	0.05	0.20	
H	0.027	0.043	0.70	1.10	
J	0.058	0.062	1.47	1.57	
K	0.195	0.205	4.95	5.21	
M	0.039	0.049	0.99	1.24	
N	0.006	0.016	0.15	0.41	

Suggested Solder Pad Layout



Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
T_J	Operating Junction Temperature Range		-55		150	°C
T_{stg}	Storage Temperature Range		-55		150	°C
$R_{th(J-L)}$	Thermal Resistance from Junction to Lead	Note 1		20		°C/W
$R_{th(J-A)}$	Thermal Resistance from Junction to Ambient	Note 1		80		°C/W
$R_{th(J-A)}$	Thermal Resistance from Junction to Ambient	Note 2		70		°C/W

Note:

1. On glass epoxy P.C.B. mounted on 0.05 x 0.05" (1.3 x 1.3mm) pads.

2. On aluminum substrate P.C.B. with an area of 0.8" x 0.8" (20 x 20mm) mounted on 0.05 x 0.05" (1.3 x 1.3mm) solder pad.

Electrical Characteristics @ 25°C Unless Otherwise Specified (Per Diode)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Forward Voltage	V_F	$I_F=0.4A; T_J=25^\circ C$			1.0	V
Reverse Current	I_R	at Rated $V_R; T_J=25^\circ C$ at Rated $V_R; T_J=125^\circ C$			5 100	μA
Junction Capacitance	C_J	$V_R=4V; f=1MHz; T_J=25^\circ C$		13	35	pF

Curve Characteristics

Fig. 1 - Forward Current Derating Curve

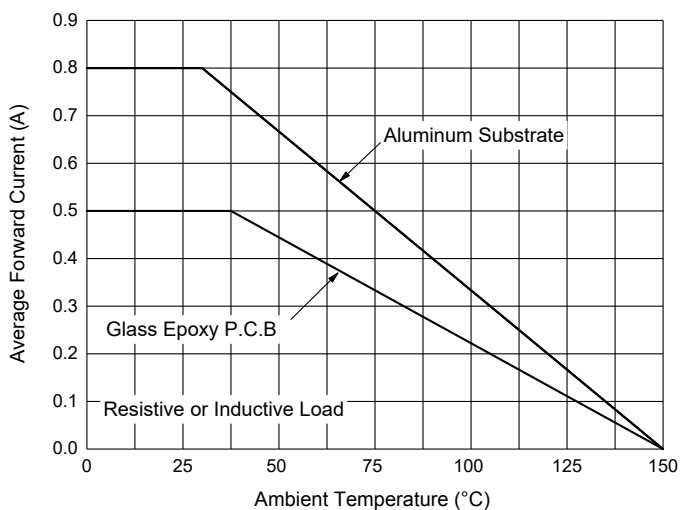


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

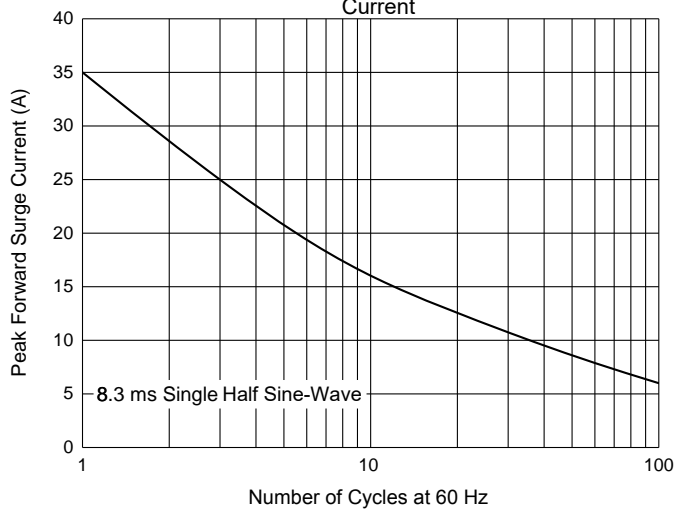


Fig. 3 - Typical Forward Characteristics

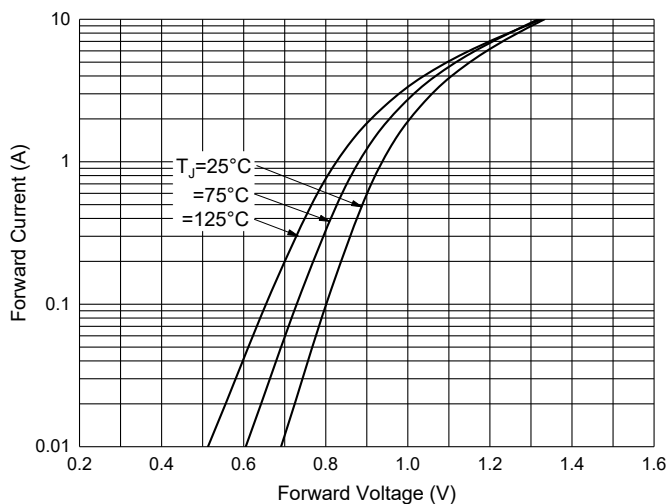


Fig. 4 - Typical Reverse Leakage Characteristics

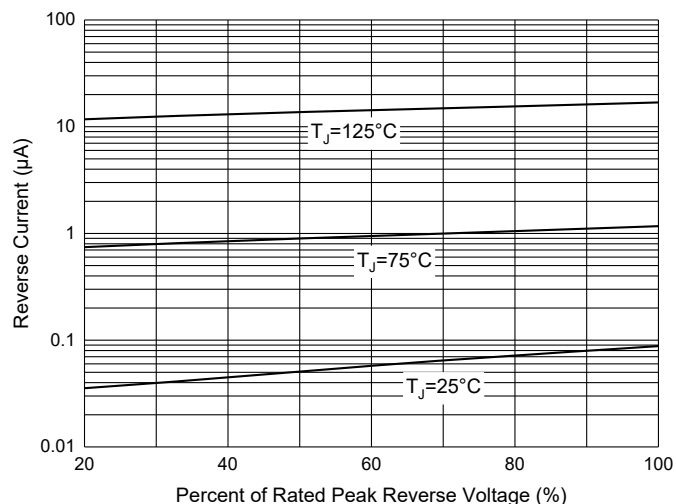
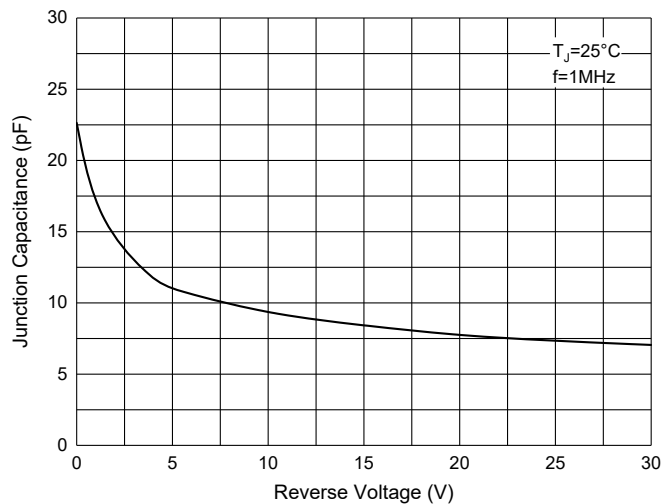


Fig. 5 - Typical Capacitance Characteristics



Ordering Information

Device	Packing
Part Number-TP	Tape&Reel:3Kpcs/Reel

Note : Adding "-HF" Suffix For Halogen Free, eg. Part Number-TP-HF

IMPORTANT NOTICE

Micro Commercial Components Corp. reserves the right to make changes without further notice to any product herein to make corrections, modifications, enhancements, improvements, or other changes. *Micro Commercial Components Corp.* does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold *Micro Commercial Components Corp.* and all the companies whose products are represented on our website, harmless against all damages. *Micro Commercial Components Corp.* products are sold subject to the general terms and conditions of commercial sale, as published at <https://www.mccsemi.com/Home/TermsAndConditions>.

LIFE SUPPORT

MCC's products are not authorized for use as critical components in life support devices or systems without the express written approval of Micro Commercial Components Corporation.

CUSTOMER AWARENESS

Counterfeiting of semiconductor parts is a growing problem in the industry. Micro Commercial Components (MCC) is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. MCC strongly encourages customers to purchase MCC parts either directly from MCC or from Authorized MCC Distributors who are listed by country on our web page cited below. Products customers buy either from MCC directly or from Authorized MCC Distributors are genuine parts, have full traceability, meet MCC's quality standards for handling and storage. **MCC will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources.** MCC is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

- [⊖ View MB8S-TP on WIN SOURCE](#)
- [⊖ Micro Commercial Co Information](#)

Optimize Your Supply Chain with WIN SOURCE Solutions

- ✓ Global Sourcing Solution
- ✓ Obsolete Management
- ✓ Cost Control Management
- ✓ Shortage Management
- ✓ Alternative Solution
- ✓ Excess Inventory Management